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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/808,261	03/14/2001	Suraj J. Mathew	303.744US1	3364

7590

10/03/2002

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EXAMINER

LATTIN, CHRISTOPHER W

ART UNIT PAPER NUMBER

2812

DATE MAILED: 10/03/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

09/808,261

Applicant(s)

MATHEW ET AL.

Examiner

Christopher W Lattin

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☐ Responsive to communication(s) filed on ____.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-50 is/are pending in the application.
- 4a) Of the above claim(s) 25-50 is/are withdrawn from consideration.
- 5) ☐ Claim(s) ____ is/are allowed.
- 6) ☒ Claim(s) 1-24 is/are rejected.
- 7) ☐ Claim(s) ____ is/are objected to.
- 8) ☐ Claim(s) ____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on ____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on ____ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. §§ 119 and 120

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
- ☐ Certified copies of the priority documents have been received.
 - ☐ Certified copies of the priority documents have been received in Application No. ____.
 - ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☒ Information Disclosure Statement(s) (PTO-1449) Paper No(s) 3.
- 4) ☐ Interview Summary (PTO-413) Paper No(s) ____.
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other: _____

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DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of claims 1-24 in Paper No. 5 is acknowledged.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in-

- (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or
- (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).

Claims 6-24 are rejected under 35 U.S.C. 102(e) as being anticipated by Rengarajan et al. (U.S. Patent 6,323,103).

In reference to claims 6-12, Rengarajan et al. teach a method of forming a first gate dielectric layer 12 on a semiconductor substrate 10, forming a first conductivity type semiconductor layer 14 on top of the first gate dielectric layer 12, selectively removing a portion of the first conductivity type semiconductor layer 14 to expose the first gate dielectric 12, the portion defining a first conductivity type well region, forming a first conductivity type semiconductor well 30 in the first conductivity type well region, removing the first gate dielectric layer 12 in the first conductivity type well region to

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expose a portion of the first conductivity type semiconductor well, forming a second gate dielectric layer 12' over the exposed portion of the first conductivity type semiconductor well 30, depositing a second conductivity type semiconductor layer 34 on the second gate dielectric layer 12', and forming a second conductivity type gate 44 from the second conductivity type semiconductor layer and forming source/drain regions 48 adjacent the gate.

In reference to claims 18-24, Rengarajan et al. teach a method of forming a second conductivity type semiconductor well 11 in a semiconductor substrate 10, forming a first gate dielectric layer 12 on the semiconductor substrate 10, forming a first conductivity type semiconductor layer 14 on top of the first gate dielectric layer 12, over the second conductivity type semiconductor well 11, selectively removing a portion of the first conductivity type semiconductor layer 14 to expose the first gate dielectric 12, the portion defining a first conductivity type well region, forming a first conductivity type semiconductor well 30 in the first conductivity type well region, removing the first gate dielectric layer 12 in the first conductivity type well region to expose a portion of the first conductivity type semiconductor well 30, forming a second gate dielectric layer 12' over the exposed portion of the first conductivity type semiconductor well, depositing a second conductivity type semiconductor layer 34 on the second gate dielectric layer 12', patterning and forming gates 42 and 44 from the first conductivity type semiconductor layer 14 and the second conductivity type semiconductor layer 34 and forming source/drain regions 48 and 52 adjacent the gates.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 1-5 and 13-17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Rengarajan et al. (U.S. Patent 6,323,103) in view of Choi et al. (U.S. Patent 5,750,424).

In reference to claims 1-5, Rengarajan et al. teach a method of forming a gate dielectric layer 12 on the semiconductor substrate 10, forming a first conductivity type semiconductor layer 14 on top of the first gate dielectric layer 12, over the second conductivity type semiconductor well 11, selectively removing a portion of the first conductivity type semiconductor layer 14 to expose the first gate dielectric 12, the portion defining a first conductivity type well region, forming a first conductivity type semiconductor well 30 in the first conductivity type well region, depositing a second conductivity type semiconductor layer 34 on a gate dielectric layer, and forming a second conductivity type gate 44 from the second conductivity type semiconductor layer 34 and forming source/drain regions 48 adjacent the gate, but fail to teach that the gate oxide is retained and not replaced following implantation. Choi et al. teach a method of forming a gate oxide 14, implanting ions through oxide 14 to form a well region and forming a semiconductor gate layer on the oxide in order to reduce processing time. It would have been obvious to one skilled in the art at the time of the

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invention to use oxide 12 in Rengarajan et al. as a gate oxide in order to reduce processing steps, time and cost.

In reference to claims 13-17, Rengarajan et al. teach a method of forming a second conductivity type semiconductor well 11 in a semiconductor substrate 10, forming a gate dielectric layer 12 on the semiconductor substrate 10, forming a first conductivity type semiconductor layer 14 on top of the first gate dielectric layer 12, over the second conductivity type semiconductor well 11, selectively removing a portion of the first conductivity type semiconductor layer 14 to expose the first gate dielectric 12, the portion defining a first conductivity type well region, forming a first conductivity type semiconductor well 30 in the first conductivity type well region, depositing a second conductivity type semiconductor layer 34 on a gate dielectric layer, patterning and forming gates 42 and 44 from the first conductivity type semiconductor layer 14 and the second conductivity type semiconductor layer 34 and forming source/drain regions 48 and 52 adjacent the gates, but fail to teach that the gate oxide is retained and not replaced following implantation. Choi et al. teach a method of forming a gate oxide 14, implanting ions through oxide 14 to form a well region and forming a semiconductor gate layer on the oxide in order to reduce processing time. It would have been obvious to one skilled in the art at the time of the invention to use oxide 12 in Rengarajan et al. as a gate oxide in order to reduce processing steps, time and cost.


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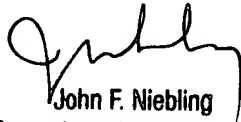
Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Christopher Lattin whose telephone number is (703) 305-3017. The examiner can normally be reached Monday through Friday from 8:00 A.M. to 5:00 P.M.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, John Niebling, can be reached at (703) 308-3325. The fax numbers for this Group are (703) 872-9318 for responses to non-final actions and (703) 872-9319 responses to final actions.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956.

CWL 
September 30, 2002


John F. Niebling
Supervisory Patent Examiner
Technology Center 2800